WiLink™ 8 Cryptographic Engine

Part Number(HW): WL1837MOD

Firmware Version 100860185

Non-proprietary FIPS 140-2 Security Policy

Version 1.1

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1. Cryptographic Module Specification

This document is the non-proprietary FIPS 140-2 Security Policy for WL1837MOD of the TI WiLink™ 8 Wi-Fi/BT Combo. This Security Policy contains the security rules under which the module must be operated and describes how this module meets the requirements as specified in FIPS PUB 140-2 (Federal Information Processing Standards Publication 140-2) for a Security Level **1** module. The following sections describe the cryptographic module and how it conforms to the FIPS 140-2 specification in each of the required areas.

1.1. Module Overview

The WiLink™ 8 Cryptographic Engine (hereafter referred to as “the WiLink™ module” or “the module”) provides IEEE 802.11i compliant AES-CCM mode encryption and decryption functionality for use in the WLAN MAC platform. It is optimized for 802.11 CCMP protocol and supports this mode only. The CCM mode is wrapped by a hardware (HW) accelerator which translates the WLAN packets into the required CCM parameters (nonce/IV, AAD payload).

Figure 1 is the high-level block diagram and shows the main components of the WiLink™ 8 chip. The physical boundary of the module under test is the continuous enclosure of the WiLink™ 8 chip indicated by the red rectangle. The Logical boundary of the module is indicated by the blue rectangle.

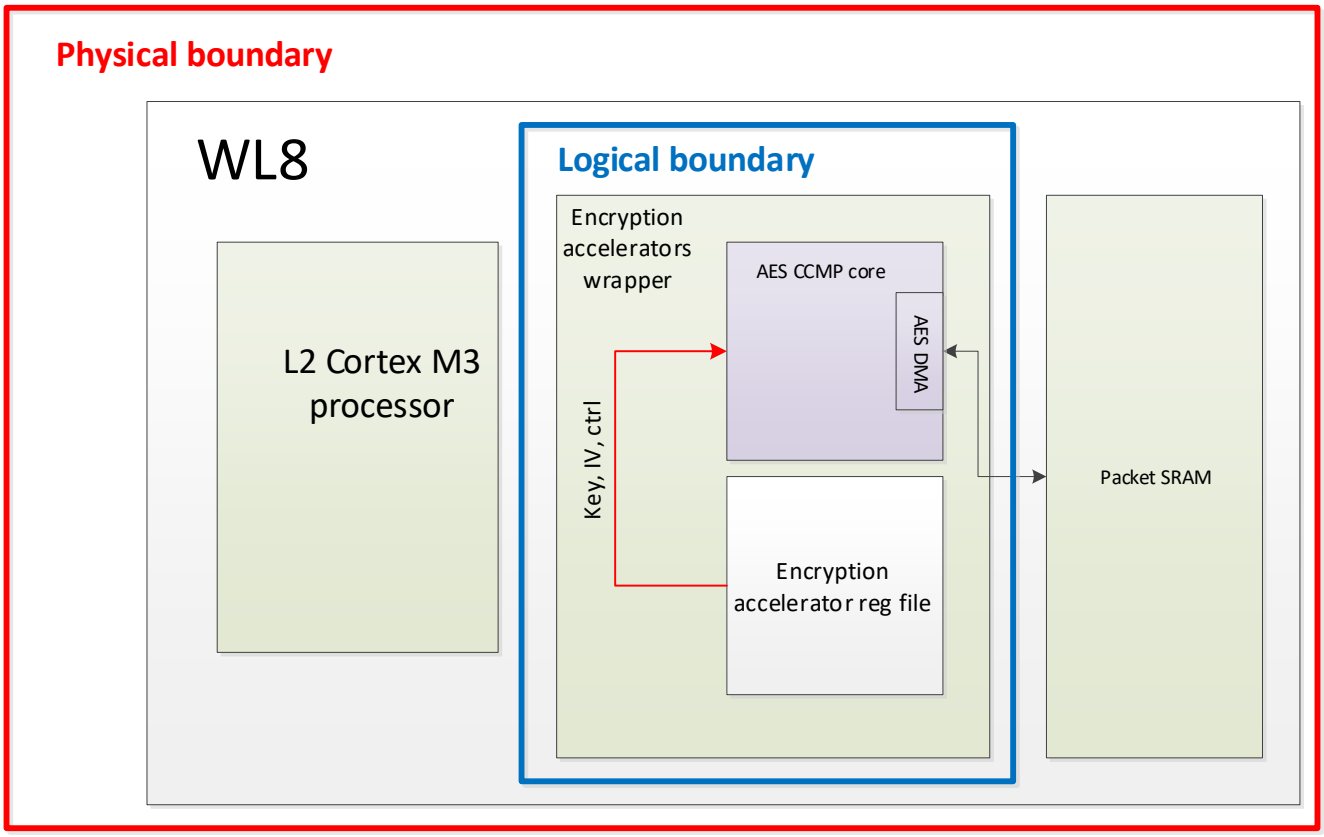

Figure 1 – Physical and Logical Boundaries of the module

The logical boundary of the module consists of the hardware implementation of AES-CCMP, the encryption accelerator register files and the firmware that runs and drives the AES hardware engine. The version of the firmware is 100860185.

For the purpose of the FIPS 140-2 validation, this is a hard circuitry core sub-chip module in a single-chip embodiment per FIPS 140-2 IG 1.20. Figure 2 shows the front and back view of the TI WiLink™ 8 chip.

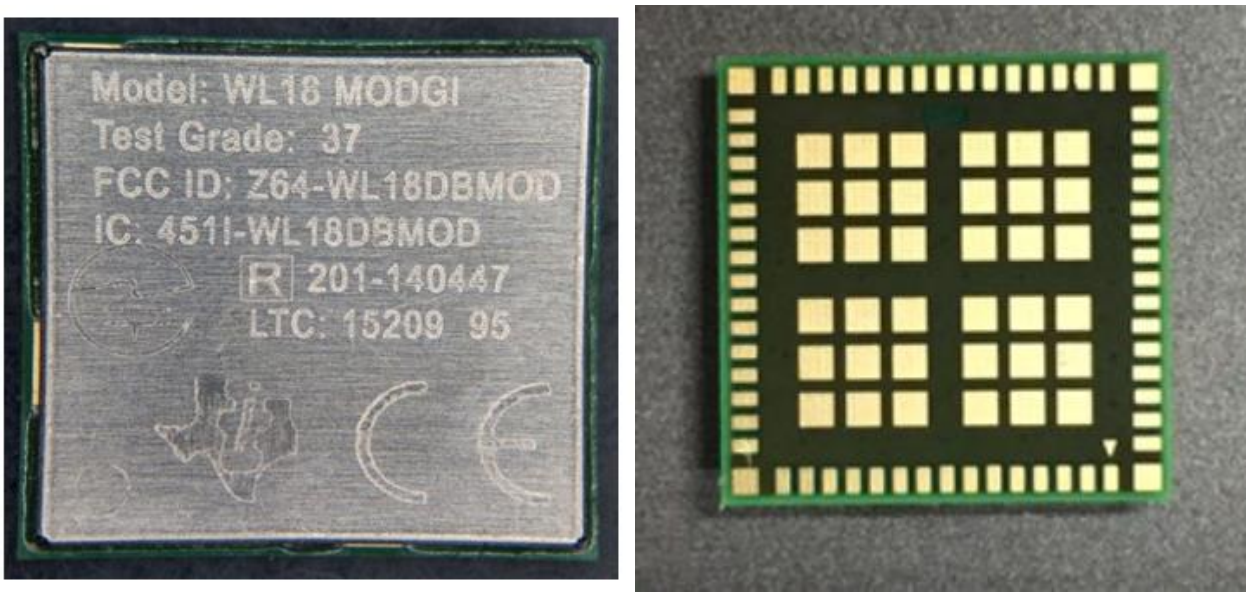

Figure 2 – Front and back views of the TI WiLink™ 8 chip.

1.2. FIPS 140-2 Validation

For the purpose of the FIPS 140-2 validation, the module is a hardware sub-chip module that resides on a TI WiLink™ 8 chip. It is to be validated at overall Security Level **1**. Table 1 shows the security level claimed for each of the eleven sections that comprise the FIPS 140-2 standard:

Table 1 - Security levels of each FIPS 140-2 sections.

FIPS 140-2 Section		Security Level
1	Cryptographic Module Specification	1
2	Cryptographic Module Ports and Interfaces	1
3	Roles, Services and Authentication	1
4	Finite State Model	1
5	Physical Security	1
6	Operational Environment	N/A
7	Cryptographic Key Management	1
8	EMI/EMC	1
9	Self-Tests	1
10	Design Assurance	1
11	Mitigation of Other Attacks	N/A
Overall Level		**1**

1.3. Modes of operation

The module only supports the FIPS mode of operation. It enters the FIPS mode after the successful completion of Power-On Self-Test (POST).

2. Cryptographic Module Ports and Interfaces

Figure 3 is the elaborated diagram of the components of the module within the module's logical boundary (see Figure 1 for the depiction of the logical boundary).

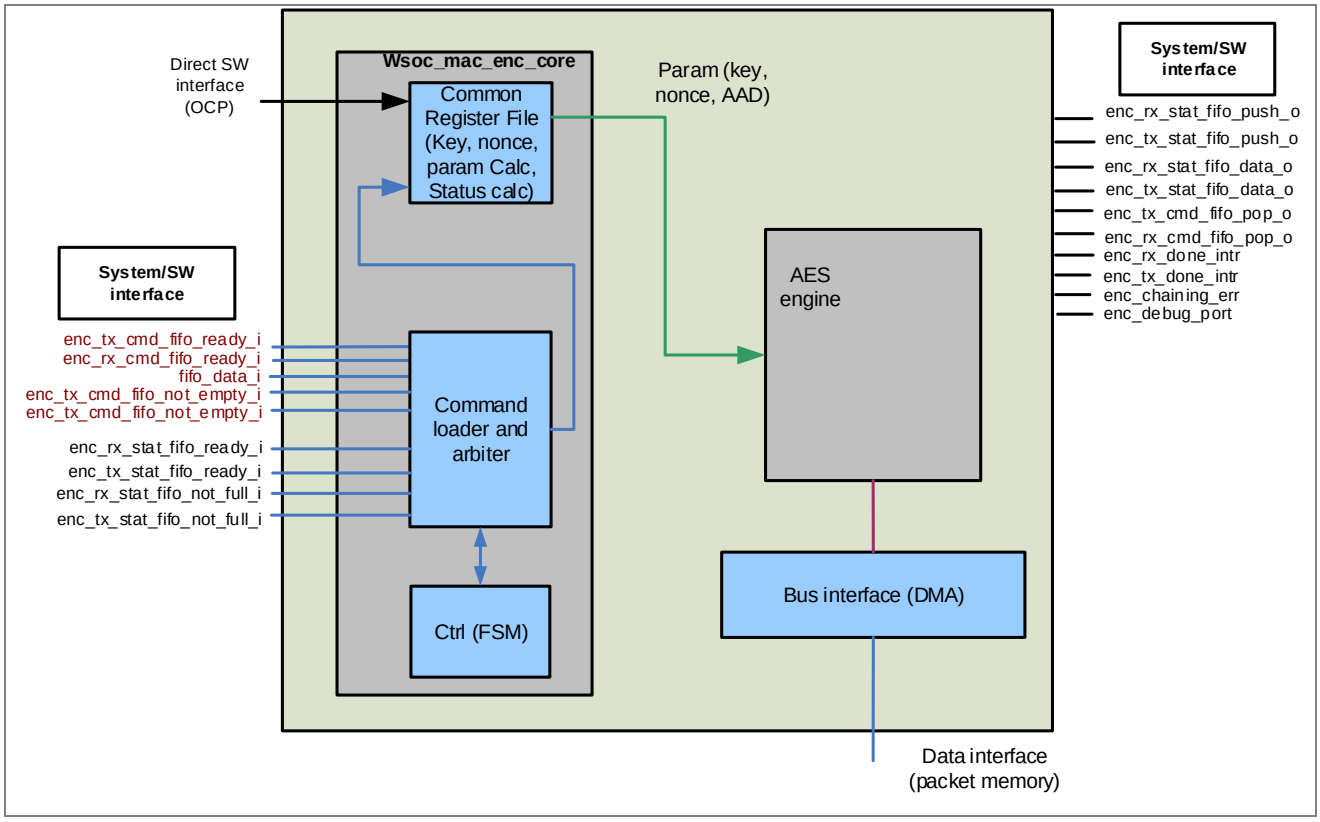

Figure 3 – Ports and interfaces of the module.

Table 2 summarizes the mapping between the four logical interfaces required by the FIPS 140-2 and the physical ports of the module:

Table 2 - Ports and interfaces of the module.

Logical Interface	Physical Port	Description
Data Input	OCP fifo_data_i DMA	SW (Software) interface – command word (command is comprised of 5 such words)
Data Output	OCP fifo_data_i DMA	HW response word (status of operation – pass/fail/bus_err)
Control Input	enc_tx_cmd_fifo_ready_i enc_rx_cmd_fifo_ready_i enc_tx_cmd_fifo_not_empty_i enc_rx_cmd_fifo_not_empty_i enc_tx_cmd_fifo_pop_o enc_rx_cmd_fifo_pop_o	Control interface to command fifo (SW interface fifo) The enc_debug_port does not contain or export the key, and this port is not used in the production module.

Logical Interface	Physical Port	Description
	enc_debug_port	
Status Output	enc_rx_stat_fifo_ready_i enc_tx_stat_fifo_ready_i enc_rx_stat_fifo_not_full_i enc_tx_stat_fifo_not_full_i enc_rx_stat_fifo_push_o enc_tx_stat_fifo_push_o enc_rx_stat_fifo_data_o enc_tx_stat_fifo_data_o enc_rx_done_intr enc_tx_done_intr enc_chaining_err	Control interface to status fifo (SW interface fifo) Interrupt signals exist but are not directly used (status fifo not empty is used to signal completion)
Power input	Power Supply Port	Not applicable for the sub-chip module. The module receives power from the device in which the module is embedded.

3. Roles, Services and Authentication

3.1. Roles

The module supports the following roles:

- **User role**: performs all services, except module installation and configuration.
- **Crypto Officer role**: performs module installation and configuration.

The User and Crypto Officer roles are implicitly assumed by the entity accessing the module services.

3.2. Services

The module provides services to users who assume one of the available roles. Table 3 shows the approved services in FIPS mode of operation, the cryptographic algorithms supported for each service, the roles that can perform each service, and the keys involved and how they are accessed. Since the module always operates in FIPS mode, Table 3 includes all services. The details about the AES algorithm supported by the module are found in Section 3.3.

Table 3 - Services in the FIPS mode of operation.

Service	Algorithms	Role	Access	Keys
Cryptographic Library Services				
Symmetric encryption and decryption	AES (ECB, CCM)	User	Read	AES keys
Other FIPS-related Services				
Show status	n/a	User	N/A	None
Self-Tests	AES	User	N/A	None
Module installation (e.g., importing AES keys)	n/a	Crypto Officer	Write	AES keys
Module configuration (e.g., updating AES keys)	n/a	Crypto Officer	Write	AES keys
Zeroization	n/a	Crypto Officer	Write	AES keys

3.3. Algorithms

The AES algorithm that is implemented in the module and approved to be used in FIPS mode of operation is tested and validated by the CAVP. Table 4 shows the cryptographic algorithms that are approved in FIPS mode of operation.

Table 4 - FIPS-Approved cryptographic algorithms.

CAVP Cert#	Algorithm	Standard	Mode / Method	Key size	Use
#5324	AES	[FIPS197] [SP800-38A]	ECB, CCM	128 bits	Data Encryption and Decryption

3.4. Operator Authentication

The module does not implement user authentication. The role of the user is implicitly assumed based on the service that is requested.

4. Physical Security

The module is a sub-chip module implemented as part of the TI WiLink™ 8 chip. The TI WiLink™ 8 chip defines the physical boundary of the sub-chip module.

The TI WiLink™ 8 chip is a single chip with a production-grade enclosure and hence conforms to the Level 1 requirements for physical security.

5. Operational Environment

The module is a hardware sub-chip module as part of TI WiLink™ 8 chip. The procurement, build and configuring procedures are controlled. Therefore, the operational environment is considered non-modifiable.

6. Cryptographic Key Management

Table 5 summarizes the keys that are used by the cryptographic services implemented in the module:

Table 5 - Life-cycle of AES keys.

Name	Generation	Entry and Output	Storage	Zeroization
AES keys	N/A. Keys are externally generated.	Keys enter the module via the data input interface as shown in Section 2. There is no key output.	Stored in register within the module	The on-demand zeroization is done via power-off and then power-on again. Key zeroization can also be done by explicitly setting the 'Key' registers in the 'wsoc_mac_enc' to 0 by the SW (Software).

6.1. Key Generation

The module does not generate any keys or Critical Security Parameters (CSPs).

6.2. Key Entry / Output

The module does not support manual key entry or intermediate key output. AES keys are generated outside of the cryptographic logical boundary of the device, e.g., via the IEEE 802.11i 4-way handshake process that generates the Temporal Key (TK) utilized by the AES-CCMP. In this process, an operator typically enters a pre-shared key (PSK) via a user interface (e.g., in the case of WPA2-PSK). The PSK is utilized in the 4-way handshake to finally derive the AES keys, again outside of the cryptographic boundary of the module. The AES keys are then provided to the module via the dedicated data input interface.

The module does not output keys in plaintext format outside its physical boundary.

6.3. Key Storage

The AES key is stored in the register within the module. The module does not provide persistent key storage.

6.4. Key Zeroization

The AES key is zeroized when the module is powered off. An alternative method consists in setting the 'key' registers in the 'wsoc_mac_enc' to 0 by the SW (Software).

7. Electromagnetic Interference/Electromagnetic Compatibility (EMI/EMC)

The sub-chip module is not a standalone device. As a hardware component, it cannot be certified by the FCC. It is rather intended to be used within a larger device which would undergo standard FCC certification for EMI/EMC.

According to 47 Code of Federal Regulations, Part 15, Subpart B, Unintentional Radiators, the module is not subject to EMI/EMC regulations because it is a subassembly that is sold to an equipment manufacturer for further fabrication. That manufacturer is responsible for obtaining the necessary authorization for the equipment with the module embedded prior to further marketing to a vendor or to a user.

8. Self Tests

8.1. Power-Up Tests

The module performs the integrity check on its firmware via a CRC-16 checksum. The CRC-16 values are part of the module and computed upon production of the module by the vendor.

The module only implements one FIPS-Approved cryptographic algorithm, AES. It performs a Known-Answer Test (KAT) for AES as shown in Table 6:

Table 6 - Self-Tests performed by the module.

Algorithm	Test
AES	• KAT for AES-CCM with 128-bit key, encryption • KAT for AES-CCM with 128-bit key, decryption

For KAT, the module calculates the result of a cryptographic operation and compares it with the known value of the answer. If the computed answer does not match the known answer, the KAT fails and the module enters the Error state, wherein no cryptographic services are available and data output is prohibited.

The module performs the power-up self-tests when the it is powered-on, without any operator intervention. The power-up self-tests ensure that the AES algorithm implementation works as expected.

While the module is executing the power-up self-tests, cryptographic services are not available, and data input and output are inhibited. The module is not available to be used until the power-up self-test are completed successfully.

8.2. On-Demand Self-Tests

On-Demand self-tests can be invoked by powering-off and powering-on the module again, thus forcing the module to run the power-up self-tests.

9. Guidance

9.1. Crypto Officer Guidance

The module is delivered as part of the firmware binary that is installed in the hardware device that utilizes the TI WiLink™ 8 chip. The vendor provides the TI WiLink™ 8 chip to OEM integrators who integrate the TI WiLink™ 8 chip into their hardware devices.

The firmware includes the module and other components that drive the hardware device, such as PHY and MAC network layer functions, etc. The firmware binary is not available for direct download to the general public, nor is its source code.

9.1.1. Prerequisites

The OEM integrators obtain the firmware binary from a version-controlled GIT repository hosted by the vendor. Access to the TI-hosted repository is granted after the OEM integrators register via a registration webpage.

The module's version can be directly verified via the repository logs and information.

9.1.2. Module installation

The OEM integrators store the firmware binary into an appropriate storage within the hardware device, also known as host device.

Upon boot, the host device's processor, or host processor, transfers the firmware binary to the module's memory space. The module will then load the binary and commence the POST operations as specified in this Security Policy document. After the POST operations are successfully completed, the module is ready to operate in FIPS mode only.

AES keys are generated outside the logical boundary of the module, e.g., through the IEEE 802.11i 4-way handshake process that generates the Temporal Key (TK) utilized by the AES-CCMP. The AES keys enter the module under the Crypto Officer role via the appropriate interface as specified in Section 2 and Section 3.

9.2. User Guidance

When the module is in the ready state, it only runs in FIPS Approved mode of operation.

Consonant with Sections 1.1, 3.2 and 3.3, the module offers the AES-ECB and AES-CCM engines to provide the 802.11 CCMP protocol. Access to the provided module functions is done through calls to API functions.

9.2.1. API Functions

The on-demand zeroization is done via power-off and then power-on again. Key zeroization can also be done by explicitly setting the 'Key' registers in the 'wsoc_mac_enc' to 0 by the SW.
The module's version can be verified by calling the `ReadRevision` function.

10. Mitigation of Other Attacks

There are no mitigations from other attacks.

Appendix A. Glossary and Abbreviations

AES	Advanced Encryption Standard
AAD	Additional Authentication Data
CAVP	Cryptographic Algorithm Validation Program
CAVS	Cryptographic Algorithm Validation System
CCM	Counter with CBC-MAC
CCMP	Counter Mode Cipher Block Chaining Message Authentication Code Protocol, or CCM mode Protocol
CMVP	Cryptographic Module Validation Program
CSP	Critical Security Parameter
CTR	Counter Mode
ECB	Electronic Code Book
FIPS	Federal Information Processing Standards Publication
HW	Hardware
KAT	Known-Answer Test
MAC	Message Authentication Code
NIST	National Institute of Science and Technology
OCP	Open Core Protocol
POST	Power-On Self-Test
SDR	Software-Defined Radio
SW	Software
WLAN	Wireless Local Area Network

Appendix B. References

FIPS140-2 **FIPS PUB 140-2 - Security Requirements For Cryptographic Modules**
May 2001
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